

# DS1649/DS3649/DS1679/DS3679 Hex TRI-STATE® TTL to MOS Drivers

### **General Description**

The DS1649/DS3649 and DS1679/DS3679 are Hex TRI-STATE MOS drivers with outputs designed to drive large capacitive loads up to 500 pF associated with MOS memory systems. PNP input transistors are employed to reduce input currents allowing the large fan-out to these drivers needed in memory systems. The circuit has Schottky-clamped transistor logic for minimum propagation delay, and TRI-STATE outputs for bus operation.

The DS1649/DS3649 has a  $15\Omega$  resistor in series with the outputs to dampen transients caused by the fast-switching

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output. The DS1679/DS3679 has a direct low impedance output for use with or without an external resistor.

### **Features**

- High speed capabilities
  - Typ 9 ns driving 50 pF
  - Typ 30 ns driving 500 pF
- TRI-STATE outputs for data bussing
- Built-in 15Ω damping resistor (DS1649/DS3649)
- Same pin-out as DM8096 and DM74366

### **Schematic Diagram**

# \*DS1649/DS3649 only

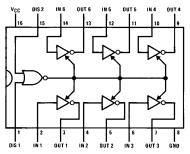
## **Truth Table**

Disable Input		Innut	Output		
DIS 1	DIS 2	mput	Output		
0	0	0	1		
0	0	1	0		
0	1	Х	Hi-Z		
1	0	Χ	Hi-Z		
1	1	Х	Hi-Z		

X = Don't care
Hi-Z = TRI-STATE mode

### **Connection Diagram**

### Dual-In-Line Package

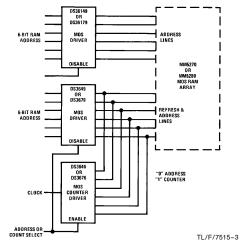


Order Number DS1649J, DS3649J, DS1679J, DS3679J, DS3649N or DS3679N See NS Package Number J16A or N16A

**Top View** 

TL/F/7515-2

### **Typical Application**



### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage Logical "1" Input Voltage 7.0V Logical "0" Input Voltage -1.5VStorage Temperature Range -65°C to +150°C

Maximum Power Dissipation\* at 25°C

Cavity Package 1371 mW Molded Package 1280 mW Lead Temperature (Soldering, 10 sec.) 300°C

### **Operating Conditions**

	Min	Max	Units
Supply Voltage (V <sub>CC</sub>	4.5	5.5	V
Temperature (T <sub>A</sub> )			
DS1649, DS1679	-55	+125	°C
DS3649, DS3679	0	+70	°C

\*Derate cavity package 9.1 mW/°C above 25°C; derate molded package 10.2 mW/°C above 25°C.

### Electrical Characteristics (Note 2 and 3)

Symbol	Parameter	Conditions		Min	Тур	Max	Units	
V <sub>IN(1)</sub>	Logical "1" Input Voltage				2.0			٧
V <sub>IN(0)</sub>	Logical "0" Input Voltage						0.8	V
I <sub>IN(1)</sub>	Logical "1" Input Current	$V_{CC} = 5.5V, V_{IN} = 5.5V$				0.1	40	μΑ
I <sub>IN(0)</sub>	Logical "0" Input Current	$V_{CC} = 5.5V, V_{IN} = 0.5V$				-50	-250	μΑ
V <sub>CLAMP</sub>	Input Clamp Voltage	$V_{CC} = 4.5V, I_{IN} = -18 \text{ mA}$				-0.75	-1.2	٧
V <sub>OH</sub>	Logical "1" Output Voltage	$V_{CC} = 4.5V, I$	$OH = -10 \mu A$	DS1649/DS1679	2.7	3.6		٧
	(No Load)			DS3649/DS3679	2.8	3.6		
V <sub>OL</sub> Logical "0" Output Voltag (No Load)	Logical "0" Output Voltage			DS1649/DS1679		0.25	0.4	٧
	(No Load)			DS3649/DS3679		0.25	0.35	٧
V <sub>OH</sub> Logical "1" Output Voltage (With Load)	Logical "1" Output Voltage	V <sub>CC</sub> = 4.5V, I <sub>OH</sub> = -1.0 mA DS1649 DS1679		DS1649	2.4	3.5		٧
	(With Load)			DS1679	2.5	3.5		٧
	DS3649 DS3679		DS3649	2.6	3.5		٧	
			2.7	3.5		٧		
V <sub>OL</sub>	V <sub>OL</sub> Logical "0" Output Voltage (With Load)	V <sub>CC</sub> = 4.5V, I <sub>OL</sub> = 20 mA DS1649 DS1679 DS3649 DS3679			0.6	1.1	٧	
				DS1679		0.4	0.5	٧
				DS3649		0.6	1.0	٧
				DS3679		0.4	0.5	٧
I <sub>1D</sub>	Logical "1" Drive Current	V <sub>CC</sub> = 4.5V, V <sub>OUT</sub> = 0V (Note 4)				-250		mA
I <sub>0D</sub>	Logical "0" Drive Current	V <sub>CC</sub> = 4.5V, V <sub>OUT</sub> = 4.5V (Note 4)			150		mA	
Hi-Z	TRI-STATE Output Current	V <sub>OUT</sub> = 0.4V to 2.4V, DIS1 or DIS2 = 2.0V			-40		40	μΑ
I <sub>CC</sub> Power	Power Supply Current	V <sub>CC</sub> = 5.5V	One DIS Input = All Other Inputs =			42	75	mA
		All Inputs = 0V			11	20	mA	

Symbol	Parameter	Con	Min	Тур	Max	Units	
t <sub>S±</sub>	Storage Delay Negative Edge	(Figure 1)	$C_L = 50  pF$		4.5	7	ns
			$C_L = 500  pF$		7.5	12	ns
t <sub>S±</sub>	Storage Delay Positive Edge	(Figure 1)	$C_L = 50 pF$		5	8	ns
			$C_L = 500  pF$		8	13	ns
t <sub>F</sub>	Fall Time	(Figure 1)	$C_L = 50 pF$		5	8	ns
			$C_L = 500  pF$		22	35	ns
t <sub>R</sub>	Rise Time	(Figure 1)	$C_L = 50 pF$		6	9	ns
			$C_L = 500  pF$		21	35	ns
t <sub>ZL</sub>	Delay from Disable Input to Logical "0" Level (from High Impedance State)	$C_L = 50 \text{ pF}$ $R_L = 2 \text{ k}\Omega \text{ to V}_{CC} \text{ (Figure 2)}$			10	15	ns
t <sub>ZH</sub>	Delay from Disable Input to Logical "1" Level (from High Impedance State)	$C_L = 50 \text{ pF}$ $R_L = 2 \text{ k}\Omega \text{ to GND (}Figure 2\text{)}$			8	15	ns
t <sub>LZ</sub>	Delay from Disable Input to High Impedance State (from Logical "0" Level)	$C_L = 50 \text{ pF}$ $R_L = 400\Omega \text{ to V}_{CC} \text{ (Figure 3)}$			15	25	ns
t <sub>HZ</sub>	Delay from Disable Input to High Impedance State (from Logical "1" Level)	$C_L = 50 \text{ pF}$ $R_L = 400\Omega \text{ to}$		10	25	ns	

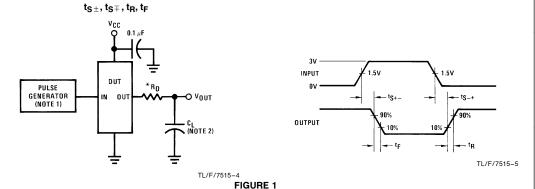
Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

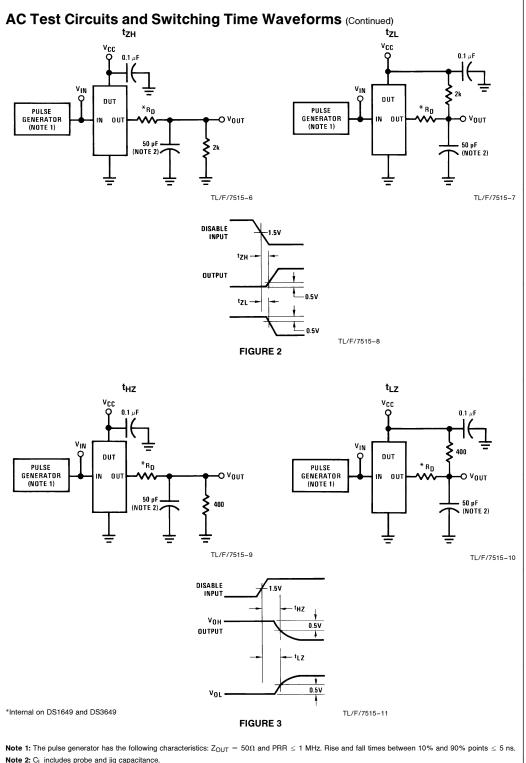
Note 2: Unless otherwise specified min/max limits apply across the  $-55^{\circ}$ C to  $+125^{\circ}$ C temperature range for the DS1649 and DS1679 and across the  $0^{\circ}$ C to  $+70^{\circ}$ C range for the DS3649 and DS3679. All typical values are for  $T_A = 25^{\circ}$ C and  $V_{CC} = 5V$ .

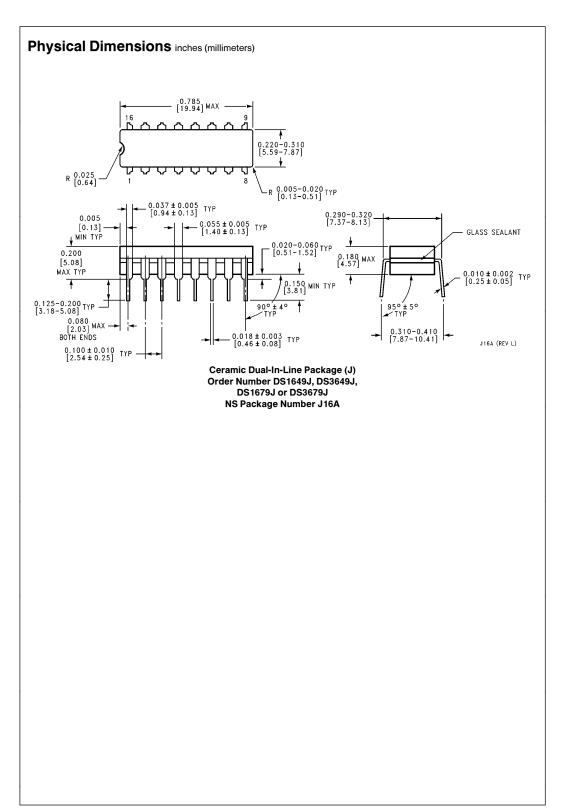
Note 3: All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

Note 4: When measuring output drive current and switching response for the DS1679 and DS3679 a  $15\Omega$  resistor should be placed in series with each output. This resistor is internal to the DS1649/DS3649 and need not be added.

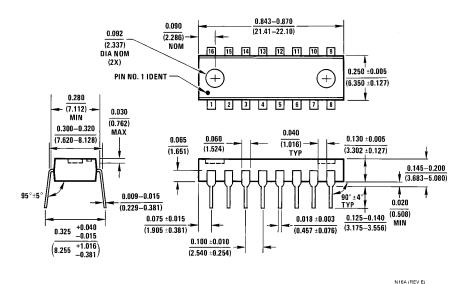
# **AC Test Circuits and Switching Time Waveforms**







### Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N) Order Number DS3649N or DS3679N NS Package Number N16A

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